



## MIKE RICE

*Corporate Vice President  
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Mike Rice is corporate vice president of Patterning and Packaging Engineering for Applied Materials, Inc. He is responsible for leading and developing core competencies and product solutions to support company growth and partnering with suppliers to deliver high-quality products. In July 2011, he was awarded the honorary designation of Applied Materials Fellow for his outstanding technical contributions that have been vital to the company's success.

Mr. Rice joined Applied Materials in 1992 as an engineering manager in Dielectric Etch and has served in roles with increasing responsibility across Etch and Foundation Engineering, most recently as general manager of Foundation Engineering. His broad capability and wealth of engineering experience has been invaluable in the development and performance of common and automation subsystems used across all of the company's product lines. Before joining Applied Materials, he led new product development for Silicon Valley Group's photolithography track division.

Mr. Rice earned a bachelor of science degree in mechanical engineering from California Polytechnical State University in San Luis Obispo. He holds more than 160 patents in plasma etching, robotics, mainframes and platform architectures.

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